

51002 U.S. PTO
10/046693
1/17/02

U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

FIG 1

APPL NUM 10046693	FILING DATE 01/17/2002	CLASS 264	SUBCLASS 313	GAU 1732	EXAMINER KUNAS
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**APPLICANTS: Lee Yeou-Ching; Wang Ming-Cheng;

**CONTINUING DATA VERIFIED:

THIS APPLICATION IS A CIP OF 09/680,295 10/06/2000 PAT 6,337,044

** FOREIGN APPLICATIONS VERIFIED:

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PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		P65993US1
Verified and Acknowledged Examiners's initials		
TITLE : Molding process for manufacturing a molded article		

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.B.
Assistant Examiner		DRAWING	
		Sheets Drwg.	Figs. Drwg.
		Print Fig.	
Primary Examiner		Application Examiner	
PREPARED FOR ISSUE			
ISSUE FEE			
Amount Due	Date Paid		
<input type="checkbox"/> TERMINAL			
DISCLAIMER			
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